

Cancelled

Title: POWER MOSFET, N-CHANNEL, RADIATION HARDENED,
HIGH RELIABILITY, SPACE USE,
DETAIL SPECIFICATION FOR
(JAXA R
2SK4048, 2SK4049, 2SK4050,
2SK4051, 2SK4052, 2SK4053,
2SK4054, 2SK4055, 2SK4056,
2SK4214, 2SK4215, 2SK4216)

Document number: JAXA-QTS-2030/101C

Cancellation date: 29 July 2022

JAXA
JAPAN AEROSPACE EXPLORATION AGENCY

Registration No.1226

JAXA-QTS-2030/101C

18 March 2020

Superseding

JAXA-QTS-2030/101B

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RADIATION HARDENED,
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DETAIL SPECIFICATION FOR

JAXA R

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2SK4051, 2SK4052, 2SK4053

2SK4054, 2SK4055, 2SK4056

2SK4214, 2SK4215, 2SK4216

Prepared and Established by Fuji Electric Co.,Ltd.

Issued by Japan Aerospace Exploration Agency

This document is the English version of JAXA QTS/ADS which was originally written and authorized in Japanese and carefully translated into English for international users. If any question arises as to the context or detailed description, it is strongly recommended to verify against the latest official Japanese version.

The release date of the English version of this specification: March 14, 2022.

Revision Log

Rev.	Date	Description
----	20 Dec. 2006	Original
A	29 Feb. 2008	Added the family type part number ▪ Added Part No.: 2SK4214, 2SK4215 and 2SK4216 (V_{DS} 130V Class) Revised to reflect the changes made to JAXA-QTS-2030C. ▪ Revised screening test in compliance with JAXA-QTS-2030C. ▪ Revised qualification test and quality conformance inspection in compliance with JAXA-QTS-2030C.
B	12 Nov. 2012	▪ Table 2b: Changed "Thermal resistance ($R_{th(ch-c)}(\Delta V_{SD})$)" to "Thermal impedance ($Z_{th(ch-c)}(\Delta V_{SD})$)" in compliance with the terms in MIL-STD-750. ▪ Table 2b: Added a test condition (Minimum On time: 30 seconds) of Intermittent Operation Life test. ▪ Table 3: Changed "Thermal resistance ($R_{th(ch-c)}(\Delta V_{SD})$)" to "Thermal impedance ($Z_{th(ch-c)}(\Delta V_{SD})$)" in compliance with the terms in MIL-STD-750. ▪ Table 3: Added a test condition (Minimum On time: 30 seconds) of Intermittent Operation Life test. ▪ Table 3: Added "(5) If the inspection lot is the one used in the Group B test, this test may be exempted" in compliance with General specification. ▪ Table 4a: Reviewed the number of significant figures in the test conditions of D-2a, D-2b and D-2c. ▪ Table 6 Exemption of Quality Conformance Inspection: Deleted test items, for which the quality conformance inspection is not performed. ▪ Added the maximum safe operating area of DC to figures. ▪ Others: Corrected errors to ensure consistency.
C	18 March 2020	▪ Cover: Changed the corporate name. ▪ Paragraph 3.2.1: Added marking for inspection lot identification code and serial number. ▪ Modified the wording in each paragraph in the document. ▪ Paragraph 6.1: Added Terms and definitions. ▪ Table 1b Group A inspection (A-3b): Corrected test condition error of gfs from "$V_{GS}=25V$" to "$V_{DS}=25V$". ▪ Table 2a Group B inspection (B-3g) and Table 2b Group B inspection (B-6g): Corrected test condition error of Bond strength from "condition A" to "condition D".

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**POWER MOSFET, N-CHANNEL, RADIATION HARDENED,
HIGH RELIABILITY, SPACE USE,
DETAIL SPECIFICATION FOR**

JAXA R

2SK4048, 2SK4049, 2SK4050

2SK4051, 2SK4052, 2SK4053

2SK4054, 2SK4055, 2SK4056

2SK4214, 2SK4215, 2SK4216

1 GENERAL

This specification establishes the detailed requirements for space use, high reliability, N channel power MOSFET (100, 130, 200 and 250V for TO-254 types) used for electronic equipment installed on spacecrafts. The products specified in this specification are as follows.

1.1 Part Number

The part numbers for the products covered by this specification are as follows:

JAXA⁽¹⁾ R⁽²⁾ 2SK4048

JAXA⁽¹⁾ R⁽²⁾ 2SK4049

JAXA⁽¹⁾ R⁽²⁾ 2SK4050

JAXA⁽¹⁾ R⁽²⁾ 2SK4051

JAXA⁽¹⁾ R⁽²⁾ 2SK4052

JAXA⁽¹⁾ R⁽²⁾ 2SK4053

JAXA⁽¹⁾ R⁽²⁾ 2SK4054

JAXA⁽¹⁾ R⁽²⁾ 2SK4055

JAXA⁽¹⁾ R⁽²⁾ 2SK4056

JAXA⁽¹⁾ R⁽²⁾ 2SK4214

JAXA⁽¹⁾ R⁽²⁾ 2SK4215

JAXA⁽¹⁾ R⁽²⁾ 2SK4216

Notes ⁽¹⁾ "JAXA" indicates the common parts for space applications.

⁽²⁾ "R" indicates the radiation hardness assurance designator.

1.2 Absolute Maximum Ratings

The absolute maximum ratings of the products specified in this specification are as follows.

Unless otherwise specified, T_A is +25°C.

Part No.	V_{DS} (V)	I_D (A)	$I_{D(pulse)}$ (A)	V_{GS} (V)	P_D $T_C=25^\circ\text{C}$ (W)	P_D $T_A=25^\circ\text{C}$ (W)	$T_{ch}^{(1)}$ (°C)	T_{stg} (°C)	$R_{th(ch-c)}$ (°C/W)	$R_{th(ch-a)}$ (°C/W)	SOA
JAXA R 2SK4048	100	42	168	±20	250 Fig.5	2.6 Fig.6	150	-55 to 150	0.5	48.0	Fig.7
JAXA R 2SK4049	100	42	168		125 Fig.8	2.58 Fig.9			1.0	48.5	Fig.10
JAXA R 2SK4050	100	15	60		62.5 Fig.11	2.55 Fig.12			2.0	49.0	Fig.13
JAXA R 2SK4051	200	42	168		250 Fig.14	2.6 Fig.15			0.5	48.0	Fig.16
JAXA R 2SK4052	200	33	132		125 Fig.17	2.58 Fig.18			1.0	48.5	Fig.19
JAXA R 2SK4053	200	14	56		62.5 Fig.20	2.55 Fig.21			2.0	49.0	Fig.22
JAXA R 2SK4054	250	42	168		250 Fig.23	2.6 Fig.24			0.5	48.0	Fig.25
JAXA R 2SK4055	250	27	108		125 Fig.26	2.58 Fig.27			1.0	48.5	Fig.28
JAXA R 2SK4056	250	12	48		62.5 Fig.29	2.55 Fig.30			2.0	49.0	Fig.31
JAXA R 2SK4214	130	42	168		250 Fig.32	2.6 Fig.33			0.5	48.0	Fig.34
JAXA R 2SK4215	130	35	140		125 Fig.35	2.58 Fig.36			1.0	48.5	Fig.37
JAXA R 2SK4216	130	15	60		62.5 Fig.38	2.55 Fig.39			2.0	49.0	Fig.40

Note⁽¹⁾ The channel temperature T_{ch} is given by the following equations:

$$T_{ch}=T_C + R_{th(ch-c)} \times P_D$$

$$T_{ch}=T_A + R_{th(ch-a)} \times P_D$$

Where T_C : Case temperature (°C)

T_A : Ambient temperature (°C)

$R_{th(ch-c)}$: Thermal resistance between channel and case (°C/W)

$R_{th(ch-a)}$: Thermal resistance between channel and ambient (°C/W)

P_D : Power dissipation (W)

1.3 Primary Electrical Characteristics

The primary electrical characteristics of the products specified in this specification are as follows. Unless otherwise specified, T_A is +25°C.

Electrical Characteristics (1/3)

Part No.	$V_{(BR)DSS}$ (V)	I_{DSS} (μA)	I_{GSS} (nA)	$V_{GS(th)}$ (V)	$R_{DS(on)}^{(1)}$ (m Ω)	$g_{fs}^{(1)}$ (S)	E_{AS} (mJ)
	$I_D=1mA$ $V_{GS}=0V$	$V_{DS}=80\%$ of rated V_{DS} $V_{GS}=0V$	$V_{GS}=\pm 20V$ $V_{DS}=0V$	$I_D=1mA$ $V_{DS}=V_{GS}$	$I_D=50\%$ of rated I_D $V_{GS}=12V$	$I_D=50\%$ of rated I_D $V_{DS}=25V$	Rated I_D $V_{DD}=48V$, $V_{GS}=12V$
	Min	Max	Max	Min-Max	Max	Min	Max
JAXA R 2SK4048	100	10	± 100	2.5-4.5	18	8	1091
JAXA R 2SK4049	100				33	8	272
JAXA R 2SK4050	100				69	4	191
JAXA R 2SK4051	200				33	8	545
JAXA R 2SK4052	200				69	8	173
JAXA R 2SK4053	200				155	4	102
JAXA R 2SK4054	250				45	8	436
JAXA R 2SK4055	250				98	8	169
JAXA R 2SK4056	250				230	4	95
JAXA R 2SK4214	130				24	8	839
JAXA R 2SK4215	130				46	8	252
JAXA R 2SK4216	130				96	4	147

Note⁽¹⁾ Pulse test: Pulse width $\leq 1ms$, Duty cycle $\leq 2\%$

Electrical Characteristics (2/3)

Part No.	Q_{GS} (nC)	Q_{GD} (nC)	Q_G (nC)	$t_{d(on)}$ (ns)	t_r (ns)	$t_{d(off)}$ (ns)	t_f (ns)
	$V_{DS}=50\%$ of rated V_{DS} , I_D = rated I_D , $V_{GS}=12V$			$V_{DD}=50\%$ of rated V_{DS} , I_D = rated I_D , $V_{GS}=12V$, $R_G=10\Omega$			
	Max	Max	Max	Max	Max	Max	Max
JAXA R 2SK4048	60	70	220	65	30	190	65
JAXA R 2SK4049	30	30	100	40	20	100	30
JAXA R 2SK4050	13	10	50	30	20	65	15
JAXA R 2SK4051	60	70	220	65	30	190	35
JAXA R 2SK4052	30	30	100	40	20	100	20
JAXA R 2SK4053	13	10	50	30	20	65	15
JAXA R 2SK4054	60	70	220	65	30	190	30
JAXA R 2SK4055	30	30	100	40	20	100	15
JAXA R 2SK4056	13	10	50	30	20	65	10
JAXA R 2SK4214	60	70	220	65	30	190	65
JAXA R 2SK4215	30	30	100	40	20	100	30
JAXA R 2SK4216	13	10	50	30	20	65	15

Electrical Characteristics (3/3)
(Body Diode Characteristics)

Part No.	$V_{SD}^{(1)}$ (V)	t_{rr} (ns)	Q_{rr} (μC)
	$I_F = \text{rated } I_D$ $V_{GS} = 0V$	$I_F = \text{rated } I_D, V_{GS} = 0V,$ $-di/dt = 100A/\mu s,$ $T_{ch} = 25^\circ C$	
	Max	Typ	Typ
JAXA R 2SK4048	1.6	450	7.0
JAXA R 2SK4049		500	6.5
JAXA R 2SK4050		350	3.5
JAXA R 2SK4051		690	13.5
JAXA R 2SK4052		800	12.0
JAXA R 2SK4053		620	6.0
JAXA R 2SK4054		1000	19.0
JAXA R 2SK4055		900	12.0
JAXA R 2SK4056		640	6.5
JAXA R 2SK4214		520	11.0
JAXA R 2SK4215		540	9.0
JAXA R 2SK4216		390	5.0

Note⁽¹⁾ Pulse test: Pulse width $\leq 1ms$, Duty cycle $\leq 2\%$

1.4 Radiation Hardness

The radiation hardness of the products specified in this specification is as follows.

Symbol	Radiation hardness assurance level
R	1000 Gy(Si) { 1×10^5 rad(Si)} (Dose Rate 36Gy(Si)/ h to 360Gy(Si)/ h)

2 APPLICABLE DOCUMENTS

The latest issues of documents listed below at the time of contract award or application form a part of this specification the extent specified herein.

JAXA-QTS-2030	Semiconductor Devices, High Reliability, Space Use, General Specification for
MIL-STD-750	Test Method Standard, Test Methods for Semiconductor Devices

3 REQUIREMENTS

3.1 Design and Construction

The design and construction of the products shall meet the requirements specified in this paragraph and paragraph 3.3 of JAXA-QTS-2030.

3.1.1 Package Configuration and Lead Connection

The package configuration and lead connection shall meet the requirements specified in Figure 1.

3.1.2 Lead Materials and Finish

The leads shall be made of Fe-Ni (Ni-Au plating) covered OCF (Oxygen-Free Copper) and plated with Au as specified in the paragraph 3.3.7 c) 2) 2.3) or with Pb-Sn solder dipping as specified in paragraph 3.3.7 c) 2) 2.1) of JAXA-QTS-2030.

3.1.3 Electrical Characteristics

The electrical characteristics shall meet the requirements specified in Tables 1a and 1b.

3.2 Marking

Marking shall be in accordance with the paragraph 3.4 of JAXA-QTS-2030, and Figure 2.

3.2.1 Marking for Inspection Lot Identification Code and Serial Number

The marking for inspection lot identification code and serial number shall be as follows.

Example:

19 01 001

a) b) c)

└───┘ └───┘

Inspection lot Serial number
identification code

- a) The last two digit number indicating the year the inspection started
- b) The two digit number indicating the week of sealing for the first inspection subplot (production lot) of each inspection lot. The week number is counted from the first week of January of the year.
- c) Unique three-digit number from 001 to 999 consecutively assigned for each product within the inspection lot

3.3 Certification

The requirements for the products to be certified shall be in accordance with paragraph 3.1 of JAXA-QTS-2030.

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4 QUALITY ASSURANCE PROVISIONS 4.1 General Requirements The general requirements shall be in accordance with the paragraph 4.1 of JAXA-QTS-2030. 4.2 Incoming Materials Control The incoming materials control shall be in accordance with the paragraph 4.2 of JAXA-QTS-2030. 4.3 Manufacturing Process Control The manufacturing process control shall be in accordance with the paragraph 4.3 of JAXA-QTS-2030. 4.4 In-process Inspection The in-process inspection shall be in accordance with the paragraph 4.5 of JAXA-QTS-2030. 4.5 Screening The screening shall be in accordance with paragraph 4.7 of JAXA-QTS-2030. The electrical characteristics to be measured, test conditions and delta limits shall be as follows.			

4.5.1 Electrical Characteristics to be Measured

The following parameters shall be measured during the interim and final electrical characteristics tests for screening.

(1) Interim electrical characteristic tests

 $T_A = +25^{\circ}\text{C}$

Measuring item	$V_{(BR)DSS}$ (V)	I_{DSS} (μA)	I_{GSS} (nA)	$V_{GS(th)}$ (V)	$R_{DS(on)}^{(1)}$ (m Ω)	$g_{fs}^{(1)}$ (S)	$V_{SD}^{(1)}$ (V)
MIL-STD-750 Test Method No.	3407	3413	3411	3404	3421	3475	---
Test conditions	Bias Condition C $I_D = 1\text{mA}$ $V_{GS} = 0\text{V}$	Bias Condition C $V_{DS} = 80\%$ of rated V_{DS} $V_{GS} = 0\text{V}$	Bias Condition C $V_{GS} = \pm 20\text{V}$ $V_{DS} = 0\text{V}$	$I_D = 1\text{mA}$ $V_{DS} = V_{GS}$	$I_D = 50\%$ of rated I_D $V_{GS} = 12\text{V}$	$I_D = 50\%$ of rated I_D $V_{DS} = 25\text{V}$	$I_F = \text{rated } I_D$ $V_{GS} = 0\text{V}$
	Min	Max	Max	Min-Max	Max	Min	Max
JAXA R 2SK4048	100	10	± 100	2.5-4.5	18	8	1.6
JAXA R 2SK4049	100				33	8	
JAXA R 2SK4050	100				69	4	
JAXA R 2SK4051	200				33	8	
JAXA R 2SK4052	200				69	8	
JAXA R 2SK4053	200				155	4	
JAXA R 2SK4054	250				45	8	
JAXA R 2SK4055	250				98	8	
JAXA R 2SK4056	250				230	4	
JAXA R 2SK4214	130				24	8	
JAXA R 2SK4215	130				46	8	
JAXA R 2SK4216	130				96	4	

Note⁽¹⁾ Pulse test: Pulse width $\leq 1\text{ms}$, Duty cycle $\leq 2\%$

(2) Final electrical characteristics test: As specified in the subgroups 1, 2 and 3 of Tables 1a and 1b.

4.5.2 Test Conditions

The conditions of gate stress test, avalanche energy test, temperature cycling test, reverse bias burn-in test and burn-in test for screening test shall be as follows.

(Gate stress test is performed as part of In-process inspection.)

Gate stress test: $V_{GS}=35V$, $t=1ms$, $T_A=25^{\circ}C$

Single pulse avalanche energy (E_{AS}) test: $I_{D(pulse)} = \text{rated } I_D$, $V_{DD}=48V$, $V_{GS}=12V$,
single pulse

Initial $T_C = +25_{-5}^{+10}^{\circ}C$

$$L(mH) = \left[\frac{2E_{AS}}{(I_D)^2} \right] \left[\frac{BV_{DSS} - V_{DD}}{BV_{DSS}} \right] \quad \bullet \bullet \text{ Equation (1)}$$

Temperature cycling test: Condition G, 20 cycles

Reverse bias burn-in test (GS): $T_A=150^{\circ}C$, $V_{GS}=16V$
 $V_{DS}=0V$, 48hr

Burn-in test (DS): $T_A=150^{\circ}C$, $V_{DS}=80\%$ of rated V_{DS}
 $V_{GS}=0V$, 240hr

4.5.3 Delta Limits

The delta limits for reverse bias burn-in test and burn-in test shall be as follows.

$$\Delta I_{GSS} \leq |20nA|$$

$$\Delta I_{DSS} \leq |10\mu A|$$

$$\Delta R_{DS(on)} \leq |20\%|$$

$$\Delta V_{GS(th)} \leq |20\%|$$

4.6 Qualification Test and Quality Conformance Inspection

The qualification test and the quality conformance inspection shall be in accordance with paragraphs 4.6 and 4.8 of JAXA-QTS-2030. External dimensions, electrical characteristics, test conditions and limits shall be as specified in Figure 1, and Tables 1, 2, 3, and 4.

Group C inspection and Group D inspection may be exempted when the qualification test or quality conformance inspection for the Groups C and D inspections were performed and the device passed the test within a year. Detailed requirements are specified in Table 6.

Group E inspection may be exempted in spite of chip size, when the semiconductor devices manufactured from the die of the same wafer lot have passed the Group E inspection in the qualification test or the quality conformance inspection.

4.6.1 Electrostatic Discharge Sensitivity Test

Electrostatic discharge sensitivity test in the qualification test shall be performed with the following lead combination:

Gate and Source

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4.6.2 Radiation Hardness Test Radiation test (TID: Total Dose Irradiation) level, electrical characteristics, test conditions and limits in the qualification tests and the quality conformance inspections shall be as specified in Table 5. The bias shall be maintained during the irradiation and post-irradiation electrical characteristics test. The post-irradiation electrical characteristics test shall be performed within 24 hours after the completion of irradiation. 4.7 Change of Tests and Inspections No change has been made to any test or inspection specified in appendixes A, B or C of JAXA-QTS -2030. 4.8 Shipment after Long-term Storage Shipment of the products stored at the manufacturer's site for 24 months or longer shall be in accordance with paragraph 4.9.1 of JAXA-QTS-2030. 5 PREPARATION FOR DELIVERY Preparation for delivery shall be in accordance with Section 5 of JAXA-QTS-2030. 6 NOTES 6.1 Terms and Definitions The terms and definitions shall be in accordance with paragraph 1.2 of JAXA-QTS-2030 and as follows. 1) SEB (Single Event Burnout) Burnout of the device caused by the incidence of a proton or a heavy ion, when the device is applied to an off-state voltage between drain and source. 2) SEGR (Single Event Gate Rupture) Breakdown of MOSFET Gate Oxide film caused by the incidence of a proton or a heavy ion, when the device is applied to a gate bias voltage between gate and source. 6.2 Notes for Purchasers The precautions to be taken by the purchaser shall be in accordance with paragraph 6.2 of JAXA-QTS-2030 and as follows. 6.2.1 Handling Instructions The products specified in this specification contain thin oxide films and can be damaged due to electrostatic discharge (ESD). ESD protection measures shall be implemented to avoid ESD between the gate and source and between the gate and drain during transportation and other handling environments.			

6.2.2 Beryllia Warning

The products of TO-254 package contain beryllium. Disintegration or chemical processing of the products that may produce dusts or fumes shall be prohibited. Disposition of the products shall be performed in accordance with applicable regulations.

Table 1a. Group A Inspection ⁽¹⁾

Gr.No	MIL-STD-750				100V Class			130V Class			200V Class			250V Class		
	Sub	Test Item	Method	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
A -1 Static Characteristics (T _A =25°C)				Sample Size	LTPD 3											
-1a	Breakdown Voltage Drain to Source V _{DSS}	3407	Conditions	Bias Condition C I _D =1mA, V _{GS} =0V												
			Limits	min 100V DC			min 130V DC			min 200V DC			min 250V DC			
-1b	Gate-to-Source Leakage Current I _{GSS}	3411	Conditions	Bias Condition C V _{GS} =±20V, V _{DS} =0V												
			Limits	max ±100nA DC												
-1c	Drain Current I _{DSS}	3413	Conditions	Bias Condition C V _{DS} =80V, V _{GS} =0V			Bias Condition C V _{DS} =104V, V _{GS} =0V			Bias Condition C V _{DS} =160V, V _{GS} =0V			Bias Condition C V _{DS} =200V, V _{GS} =0V			
			Limits	max 10μA DC												
-1d	Gate to Source Voltage (Threshold) V _{GS(th)}	3404	Conditions	Bias Condition C V _{GS} =V _{DS} , I _D =1mA												
			Limits	2.5 - 4.5V DC												
-1e	Static Drain to Source On-State Resistance R _{DS(on)}	3421	Conditions	Pulse Test ⁽²⁾ , V _{GS} =12V												
			Limits	I _D 21A 21A 7.5A			I _D 21A 17.5A 7.5A			I _D 21A 16.5A 7A			I _D 21A 13.5A 6A			
-1f	Forward Transconductance g _{fs}	3475	Conditions	Pulse Test ⁽²⁾ , V _{DS} =25V												
			Limits	I _D 21A 21A 7.5A			I _D 21A 17.5A 7.5A			I _D 21A 16.5A 7A			I _D 21A 13.5A 6A			
-1g	Forward Voltage V _{SD}	---	Conditions	Pulse Test ⁽²⁾ , V _{GS} =0V												
			Limits	I _F 42A 42A 15A			I _F 42A 35A 15A			I _F 42A 33A 14A			I _F 42A 27A 12A			
				max 1.6V												
A -2 Static Characteristics (T _A =125°C)				Sample Size	LTPD 5											
-2a	Gate to Source Leakage Current I _{GSS} (125°C)	3411	Conditions	Bias Condition C V _{GS} =±20V, V _{DS} =0V												
			Limits	max ±100nA DC												
-2b	Drain Current I _{DSS} (125°C)	3413	Conditions	Bias Condition C V _{DS} =80V, V _{GS} =0V			Bias Condition C V _{DS} =104V, V _{GS} =0V			Bias Condition C V _{DS} =160V, V _{GS} =0V			Bias Condition C V _{DS} =200V, V _{GS} =0V			
			Limits	max 25μA DC												
-2c	Gate to Source Voltage (Threshold) V _{GS(th)} (125°C)	3404	Conditions	Bias Condition C V _{GS} =V _{DS} , I _D =1mA												
			Limits	min 1.5V DC												
-2d	Static Drain to Source On-State Resistance R _{DS(on)} (125°C)	3421	Conditions	Pulse Test ⁽²⁾ , V _{GS} =12V												
			Limits	I _D 21A 21A 7.5A			I _D 21A 17.5A 7.5A			I _D 21A 16.5A 7A			I _D 21A 13.5A 6A			
				31 56 117			44 84 175			66 138 310			90 196 460			

Notes⁽¹⁾ The same sample may be used for all subgroups.⁽²⁾ Pulse test: Pulse width ≤ 1ms, Duty cycle ≤ 2%

Table 1b. Group A Inspection ⁽¹⁾

Gr.No	MIL-STD-750				100V Class			130V Class			200V Class			250V Class		
	Sub	Test Item	Method	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
A -3	Static Characteristics (T _A =-55°C)			Sample Size												
	-3a	Gate to Source Voltage (Threshold) V _{GS(th)} (-55°C)	3404	Conditions	LTPD 5 Bias Condition C V _{GS} =V _{DS} , I _D =1mA											
				Limits	max 5.0V DC											
	-3b	Forward Transconductance g _{fs} (-55°C)	3475	Conditions	Pulse Test (2) , V _{DS} =25V											
				Limits	I _D 21A 21A 7.5A			I _D 21A 17.5A 7.5A			I _D 21A 16.5A 7A			I _D 21A 13.5A 6A		
					min 8.5S 8.5S 4.5S			min 8.5S 8.5S 4.5S			min 8.5S 8.5S 4.5S			min 8.5S 8.5S 4.5S		
A -4	Dynamic Characteristics (T _A =25°C)			Sample Size												
	Switching Time Test (1) Turn-on delay time: td(on) Rise time: tr (2) Turn-off delay time: td(off) Fall time: tr	3472	Conditions	V _{DD} =50V V _{GS} =12V, R _g =10Ω			V _{DD} =65V V _{GS} =12V, R _g =10Ω			V _{DD} =100V V _{GS} =12V, R _g =10Ω			V _{DD} =125V V _{GS} =12V, R _g =10Ω			
				I _D 42A 42A 15A			I _D 42A 35A 15A			I _D 42A 33A 14A			I _D 42A 27A 12A			
			Limits	max			max			max			max			
			td(on)	65ns	40ns	30ns	65ns	40ns	30ns	65ns	40ns	30ns	65ns	40ns	30ns	
			tr	30ns	20ns	20ns	30ns	20ns	20ns	30ns	20ns	20ns	30ns	20ns	20ns	
			td(off)	190ns	100ns	65ns	190ns	100ns	65ns	190ns	100ns	65ns	190ns	100ns	65ns	
			tr	65ns	30ns	15ns	65ns	30ns	15ns	35ns	20ns	15ns	30ns	15ns	10ns	
A -6a	Safe Operating Area Test ⁽³⁾		Sample Size													
		3474	Conditions	LTPD 5 ---												
	-6b	End-Point Electrical Measurements	---		Same as Gr.A-1											
A -7	Other Characteristics (T _A =25°C) ⁽⁴⁾		Sample Size													
	-7a	Gate Charge (1) Gate Charge: Q _g (2) Gate to Drain Charge: Q _{gd} (3) Gate to Source Charge: Q _{gs}	3471	Conditions	V _{GS} =12V V _{DS} =50V			V _{GS} =12V V _{DS} =65V			V _{GS} =12V V _{DS} =100V			V _{GS} =12V V _{DS} =125V		
					I _D 42A 42A 15A			I _D 42A 35A 15A			I _D 42A 33A 14A			I _D 42A 27A 12A		
				Limits	max			max			max			max		
				Q _g	220nC	100nC	50nC	220nC	100nC	50nC	220nC	100nC	50nC	220nC	100nC	50nC
				Q _{gd}	70nC	30nC	10nC	70nC	30nC	10nC	70nC	30nC	10nC	70nC	30nC	10nC
		Q _{gs}	60nC	30nC	13nC	60nC	30nC	13nC	60nC	30nC	13nC	60nC	30nC	13nC		
	-7b	Reverse Recovery Characteristics (1) trr (2) Qrr	3473	Conditions	I _F = I _D 42A 42A 15A			I _F = I _D 42A 35A 15A			I _F = I _D 42A 33A 14A			I _F = I _D 42A 27A 12A		
					V _{GS} =0V -di/dt=100A/μs											
				Limits	max			max			max			max		
trr				765ns	750ns	525ns	765ns	750ns	525ns	1050ns	1200ns	950ns	1500ns	1350ns	950ns	
	Qrr	10.5μC	10.0μC	5.5μC	13.0μC	12.0μC	6.5μC	20.0μC	18.0μC	9.0μC	29.0μC	18.0μC	10.0μC			

Notes ⁽¹⁾ The same sample may be used for all subgroups.⁽²⁾ Pulse test: Pulse width ≤ 1ms, Duty cycle ≤ 2%⁽³⁾ The samples used for subgroups A-1, A-2, and A-3 tests shall be used.⁽⁴⁾ The samples used for subgroups A-6 tests shall be used.

Table 2a. Group B Inspection

Gr.No	MIL-STD-750			100V Class			130V Class			200V Class			250V Class				
	Sub	Test Item		Method	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
B -1	External Dimensions ⁽¹⁾		Sample Size	Level I (°) 3p													
			Size	Level II (°) 3p													
		2066	Conditions	See Fig. 1													
B -2	Resistance to Solvents ⁽³⁾ (4)		Sample Size	Level I 3p													
			Size	Level II 3p													
		1022	Conditions	Solvent a, b, c													
B -3b	Temperature Cycling (Air to Air)		Sample Size	Level I 6p													
			Size	Level II 6p													
		1051	Conditions	-55 ⁺⁰ ₋₅ °C↔25 ⁺¹⁰ ₋₅ °C↔150 ⁺⁵ ₋₀ °C 100 cycles													
-3c	Surge Test (1) Gate Shock	4066	Conditions	V _{GS} =35V													
		(2) Avalanche	3470	Conditions	V _{DS} =48V, L= See paragraph 4.5.2, Equation (1)												
			I _{D(pulse)} 42A 42A 15A 42A 35A 15A 42A 33A 14A 42A 27A 12A														
-3d	Hermetic Seal (1) Fine	1071	Conditions	Condition H													
		Limits	max 1×10 ⁻³ Pa·cm³/s														
		(2) Gross	1071	Conditions	--- Condition C												
-3e	End-Point Electrical Measurements	---	Conditions	Same as Gr.A-1													
-3f	Decap-Internal Visual and mechanical inspection	2075 2071	Conditions	---													
-3g	Bond Strength	2037	Conditions	Condition D													
			Limits	Gate Wire >90gf													
			Source Wire >300gf >300gf >90gf >300gf >300gf >90gf >300gf >300gf >90gf >300gf >300gf >90gf														
-3h	SEM ⁽¹⁾	2077	Conditions	---													
-3i	Die Shear		Sample Size	Level I 3p													
			Size	Level II 3p													
		2017	Conditions	---													
			Limits	min 2.5kgf													
B -4	Solderability ⁽³⁾ (4)		Sample Size	Level I 6 leads ⁽⁵⁾													
		2026	Conditions	Level II 6 leads ⁽⁵⁾ ---													

Notes ⁽¹⁾ The test may be performed using the samples prior to inspection lot formation.⁽²⁾ Level I and Level II shall be applicable to the qualification test and the quality conformance inspection, respectively. (See paragraphs C.3.2 and C.3.3 of JAXA-QTS-2030)⁽³⁾ Electrical reject products from the same inspection lot may be used.⁽⁴⁾ When electrical reject products are used, the samples shall be exposed to the same thermal environments as the certified samples experience in all thermal tests required as part of the screening test.⁽⁵⁾ This test shall be performed for each 3 lead from 2 devices.

Table 2b. Group B Inspection

Gr.No	MIL-STD-750				100V Class			130V Class			200V Class			250V Class			
	Sub	Test Item	Method	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056	
B -5a	Intermittent Operation Life			Sample Size	Level I LTPD 10												
				Level II 12p													
	1042	Conditions	Condition D, 2000 cycles ⁽¹⁾ Minimum On time: 30 seconds														
	-5b	End-Point Electrical Measurements	---		Same as Gr.A-1												
B -6c	Accelerated Steady-state Gate Bias (High Temp. GS)			Sample Size	Level I LTPD 10												
				Level II 12p													
	1042	Conditions	V _{GS} =20V, T _A =150°C, 48hr or V _{GS} =20V, T _A =175°C, 24hr														
	-6d	End-Point Electrical Measurements	---		Same as Gr.A-1												
	-6e	Accelerated Steady- state Reverse Bias (High Temp. DS)	1042	Conditions	V _{DS} =100V			V _{DS} =130V			V _{DS} =200V			V _{DS} =250V			
	T _A =150°C, 240hr or T _A =175°C, 120hr																
	-6f	End-Point Electrical Measurements	---	Conditions	Same as Gr.A-1												
	-6g	Bond Strength			Sample Size	20 wires											
2037					Conditions	Condition D											
Limits					Gate Wire >90gf												
					Source Wire >300gf >300gf >90gf >300gf >300gf >90gf >300gf >300gf >90gf >300gf >300gf >90gf												
B -7	Thermal Impedance Z _{th(ch-c)} (ΔV _{SD})			Sample Size	Level I LTPD 10												
				Level II 8p													
				3161	Conditions	T _A =25°C											
				Limits	max (°C/W) 0.5 1.0 2.0			max (°C/W) 0.5 1.0 2.0			max (°C/W) 0.5 1.0 2.0			max (°C/W) 0.5 1.0 2.0			

Note ⁽¹⁾ If the samples are also used for "Intermittent operating life test" of C1-1 in the Group C inspection, the test shall be performed up to 6000 cycles.

Table 3. Group C Inspection

Gr.No	MIL-STD-750			JAXA R	100V Class			130V Class			200V Class			250V Class			
	Sub	Test Item	Method		2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056	
C 1-1a	Intermittent Operation Life		Sample Size	Level I LTPD 10													
			1042	Conditions	Level II LTPD 10												
	1-1b	End-Point Electrical Measurements	---	Conditions	Condition D, 6000 cycles ⁽¹⁾ Minimum On time: 30 seconds												
C 1-2a	Steady-state Bias Life test (high temperature GS applied) ⁽²⁾		Sample Size	Level I LTPD 5													
			1042	Conditions	Level II NA												
	1-2b	End-Point Electrical Measurements	---	Conditions	V _{GS} =16V T _A =150°C , 1000hr												
	1-2c	Steady-state Bias Life test (high temperature DS applied) ⁽²⁾	1042	Conditions	Same as Gr.A-1												
	1-2d	End-Point Electrical Measurements	---	Conditions	V _{DS} =80V V _{DS} =104V V _{DS} =160V V _{DS} =200V T _A =150°C, 1000hr												
					Same as Gr.A-1												
C -2a	Temperature Cycling		Sample Size	Level I 12p													
			1051	Conditions	Level II NA												
	-2b	Hermetic Seal (1) Fine	1071	Conditions	-55 ⁺⁰ ₋₅ °C↔25 ⁺¹⁰ ₋₅ °C↔150 ⁺⁵ ₋₀ °C 100 cycles												
					Limits	Condition H											
						max 1×10 ⁻³ Pa·cm ³ /s											
	-2c	End-Point Electrical Measurements ⁽³⁾	---	Conditions	(2) Gross Condition C												
Same as Gr.A-1																	
C -3	Thermal Impedance ⁽⁴⁾ ⁽⁵⁾ Z _{th(ch-c)} (ΔV _{SD})		Sample Size	Level I LTPD 10													
			3161	Conditions	Level II 8p												
			Limits	T _A =25°C													
C -4a	Safe Operating Area Test ⁽⁶⁾		Sample Size	max (°C/W) max (°C/W) max (°C/W) max (°C/W)													
			3474	Conditions	0.5 1.0 2.0 0.5 1.0 2.0 0.5 1.0 2.0 0.5 1.0 2.0												
		1-4b	End-Point Electrical Measurements ⁽⁶⁾	---	Conditions	Level I LTPD 10 Level II LTPD 10 ---											
C -6a	Electric Discharge Sensitivity Classification		Sample Size	Same as Gr.A-1													
			1020	Conditions	Level I 3p Level II NA												
		1-6b	End-Point Electrical Measurements	---	Conditions	V _{GS} ±2750V ±1000V ±500V ±2750V ±1000V ±500V ±2750V ±1000V ±500V ±2750V ±1000V ±500V V _{DS} =0V											

Notes ⁽¹⁾ For the quality conformance inspection, the cycles may be reduced to 2000 cycles as a minimum.⁽²⁾ The legibility of the marking shall not apply.⁽³⁾ This test may be conducted prior to the hermetic seal.⁽⁴⁾ Thermal impedance curve shall be obtained during the qualification test.⁽⁵⁾ If the inspection lot is the one used in the Group B inspection, this test may be exempted.⁽⁶⁾ This test may be exempted if performed in the Group A inspection.

Table 4a. Group D Inspection

Gr.No	MIL-STD-750			100V Class			130V Class			200V Class			250V Class			
	Sub	Test Item	Method	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
D	-1a	Thermal Shock (Glass Strain)		Sample Size	Level I LTPD 15 Level II LTPD 15											
			1056	Conditions	Condition B, 15 cycles											
		-1b	Temperature Cycling	1051	Conditions	-55 ⁺⁰ ₋₅ °C↔25 ⁺¹⁰ ₋₅ °C↔150 ⁺⁵ ₋₀ °C 45 cycles										
	-1c	Terminal Strength	2036	Conditions	Condition A 1.5kg, 30s											
	-1d	Moisture Resistance	1021	Conditions	(MIL-STD-202, Method 106)											
	-1e	Hermetic Seal (1) Fine	1071	Conditions	Condition H											
				Limits	max 1×10 ⁻³ Pa·cm ³ /s											
		(2) Gross	1071	Conditions	Condition C											
	-1f	Visual Inspection	1051 1021	Conditions	---											
	1g	End-Point Electrical Measurements	---	Conditions	Same as Gr.A-1											
D	-2a	Shock ⁽¹⁾		Sample Size	Level I LTPD 15 Level II LTPD 15											
			2016	Conditions	No Operating, 14700m/s ² (1500G) 5 blows in each orientation, X ₁ , Y ₁ , Z ₁											
		-2b	Vibration, Variable Frequency ⁽¹⁾	2056	Conditions	100 to 2000 Hz, 4min 196 m/s ² (20G) 4 blows in each orientation X,Y,Z										
	-2c	Constant Acceleration ⁽¹⁾	2006	Conditions	98100.5m/s ² (10000G) X ₁ , Y ₁ , Y ₂ and Z ₁ orientation											
	-2d	Hermetic Seal ⁽¹⁾ (1) Fine	1071	Conditions	Condition H											
				Limits	max 1×10 ⁻³ Pa·cm ³ /s											
		(2) Gross	1071	Conditions	Condition C											
	-2e	End-Point Electrical Measurements ⁽¹⁾	---	Conditions	Same as Gr.A-1											
D	-3a	Salt Atmosphere ⁽²⁾		Sample Size	Level I LTPD 15 Level II LTPD 15											
			1041	Conditions	35°C, 24hr Rate of salt deposit=10 to 50g/m ² /24hr											

Notes ⁽¹⁾ Samples used for subgroup 1 may be used.⁽²⁾ Electrical reject products from the same inspection lot may be used.

Table 4b. Group D Inspection

Gr.No	MIL-STD-750			JAXA R	100V Class			130V Class			200V Class			250V Class		
	Sub	Test Item	Method		2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
D -4	Barometric Pressure (reduced)		Sample Size	Level I 3p Level II NA												
			1001	Conditions	Not applicable for devices with rated voltage ≤ 200V.										8mmHg 60sec (minimum) V _{DS} =250V, V _{GS} =0V	
		D -5	Internal Water Vapor (¹)		Sample Size	Level I 3p Level II 3p										
1018	Conditions				---											
D -6a	Resistance to Soldering Heat				Sample Size	Level I 3p Level II NA										
		2031	Conditions		250°C, 10s											
	-6b	Visual Inspection	---	Conditions	---											
	-6c	Hermetic Seal (1) Fine	1071	Conditions	Condition H											
				Limits	max 1×10 ⁻³ Pa·cm ³ /s											
(2) Gross		1071	Conditions	Condition C												
-6d	End-Point Electrical Measurements	---	Conditions	Same as Gr.A-1												

Note(¹) Electrical reject products from the same inspection lot may be used.

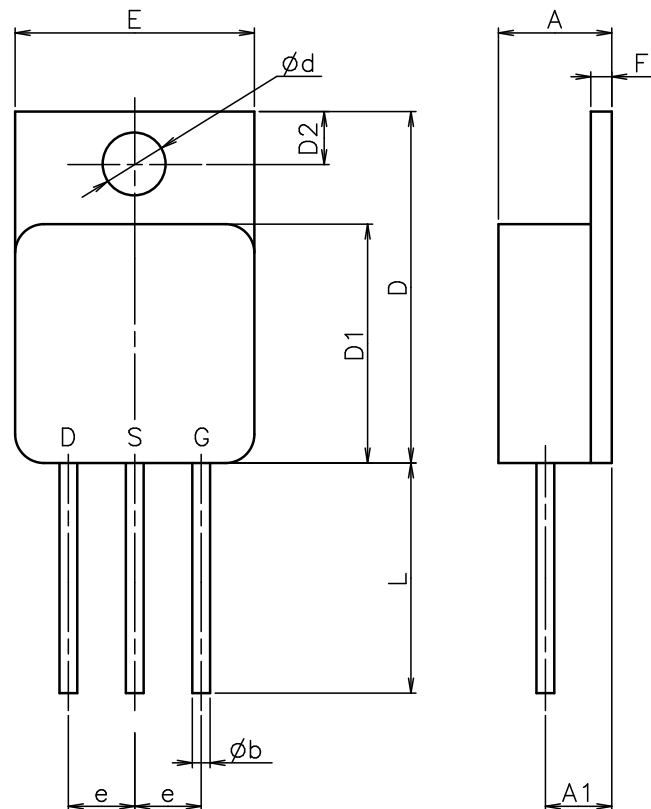
Table 5. Group E Inspection

Gr.No	MIL-STD-750				100V Class			130V Class			200V Class			250V Class		
	Sub	Test Item	Method	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
E -1a		Total Dose Irradiation (TID)		Sample Size	Level I 4p ⁽¹⁾ Level II 4p ⁽¹⁾											
			1019	Conditions	Total Dose 1×10 ³ Gy(Si) Dose Rate 36Gy(Si)/h to 360Gy(Si)/h Bias Condition (during irradiation, after irradiation) (a) V _{DS} =0V , V _{GS} =20V (b) V _{DS} =0V , V _{GS} =-20V (c) V _{DS} =80V, V _{GS} =0V (c) V _{DS} =104V, V _{GS} =0V (c) V _{DS} =160V, V _{GS} =0V (c) V _{DS} =200V, V _{GS} =0V											
-1b		End-Point Electrical Measurements			Within 24hr after irradiation											
(1)		Breakdown Voltage Drain to Source V _{DSS}	3407	Conditions	Bias Condition C I _D =1mA , V _{GS} =0V											
				Limits	min 100V DC		min 130V DC		min 200V DC		min 250V DC					
(2)		Gate-to-Source Leakage Current I _{GSS}	3411	Conditions	Bias Condition C V _{GS} =±20V , V _{DS} =0V											
				Limits	max ±100nA DC											
(3)		Drain Current I _{DSS}	3413	Conditions	Bias Condition C V _{DS} =80V , V _{GS} =0V		Bias Condition C V _{DS} =104V , V _{GS} =0V		Bias Condition C V _{DS} =160V , V _{GS} =0V		Bias Condition C V _{DS} =200V , V _{GS} =0V					
				Limits	max 10μA DC											
(4)		Gate to Source Voltage (Threshold) V _{GS(th)}	3404	Conditions	Bias Condition C V _{GS} =V _{DS} , I _D =1mA											
				Limits	min 1.5V DC ΔV _{GS(th)} max 2.0V											
(5)		Static Drain to Source On-State Resistance R _{DS(on)}	3421	Conditions	Pulse Test ⁽²⁾ , V _{GS} =12V											
				I _D			I _D			I _D			I _D			
				21A 21A 7.5A	21A 17.5A 7.5A	21A 16.5A 7A	21A 13.5A 6A									
				Limits	max [mΩ] 18 33 69			max [mΩ] 24 46 96			max [mΩ] 33 69 155			max [mΩ] 45 98 230		

Notes ⁽¹⁾ This test shall be performed for each single wafer lot. When an inspection lot consists of multiple inspection sublots, one inspection subplot may be performed this test.

⁽²⁾ Pulse test: Pulse width ≤ 1ms, Duty cycle ≤ 2%

Gr.No		100V Class			130V Class			200V Class			250V Class		
Sub	JAXA R	2SK 4048	2SK 4049	2SK 4050	2SK 4214	2SK 4215	2SK 4216	2SK 4051	2SK 4052	2SK 4053	2SK 4054	2SK 4055	2SK 4056
	JAXA-QTS-2030 Appendix C Test Item	Die Size 1/1 1/2 1/4			Die Size 1/1 1/2 1/4			Die Size 1/1 1/2 1/4			Die Size 1/1 1/2 1/4		
C	-1a	Intermittent Operation Life											
	-1b	End-Point Electrical Measurements											
	-3	Thermal Impedance											
	-4a	Safe Operating Area Test											
	-4b	End-Point Electrical Measurements											
D	-1a	Thermal Shock (Glass Strain)											
	-1b	Thermal Shock (Temperature Cycling)											
	-1c	Terminal Strength											
	-1d	Moisture Resistance											
	-1e	Hermetic Seal											
	-1f	Visual Inspection											
	-1g	End-Point Electrical Measurements											
	-2a	Shock											
	-2b	Vibration, Variable Frequency											
	-2c	Constant Acceleration											
	-2d	Hermetic Seal											
	-2e	End-Point Electrical Measurements											
	-3a	Salt Atmosphere											
	-5	Internal Water Vapor											



Symbol	Dimension (mm)	
	Min	Max
A	6.35	6.65
A1	3.61	4.01
ϕb	0.90	1.14
D	20.07	20.31
D1	13.59	13.85
D2	2.93	3.17

Symbol	Dimension (mm)	
	Min	Max
ϕd	3.56	3.80
E	13.60	13.84
e	3.51	4.11
F	1.10	1.30
L	12.84	13.60

Note: All leads are isolated from the case.

Figure 1. Package Configuration and Lead Connection of TO-254 type package

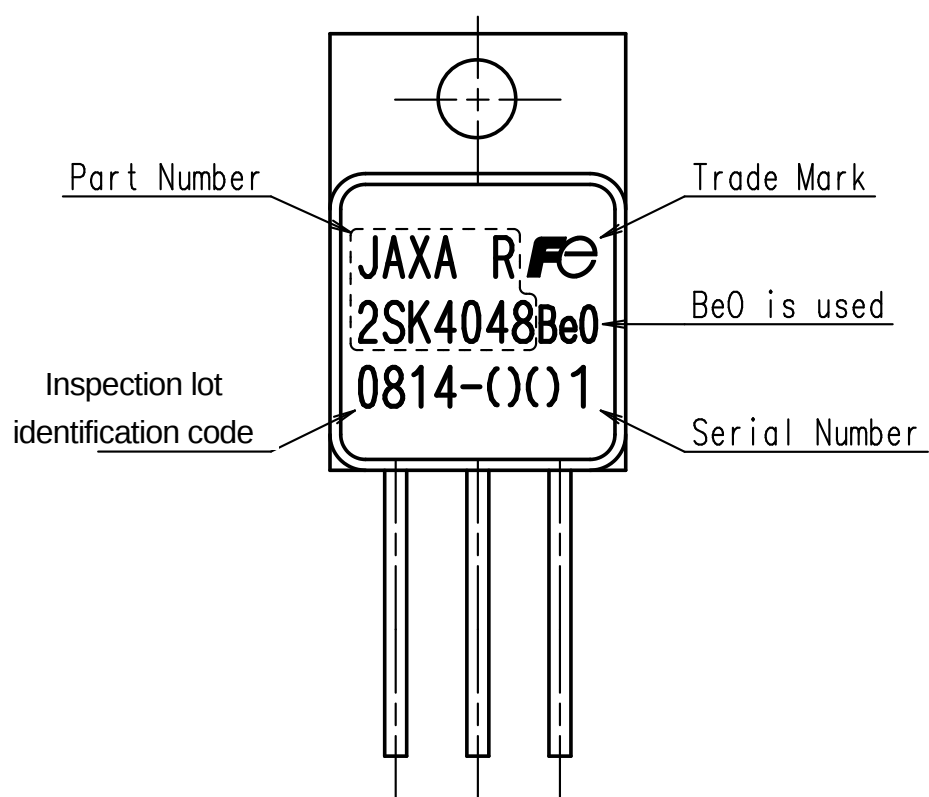


Figure 2. Marking

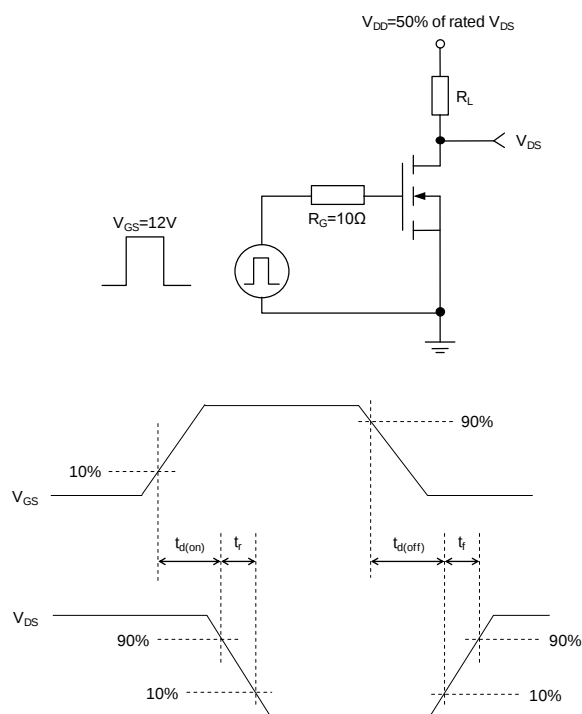


Figure 3. Switching time test circuit and waveforms

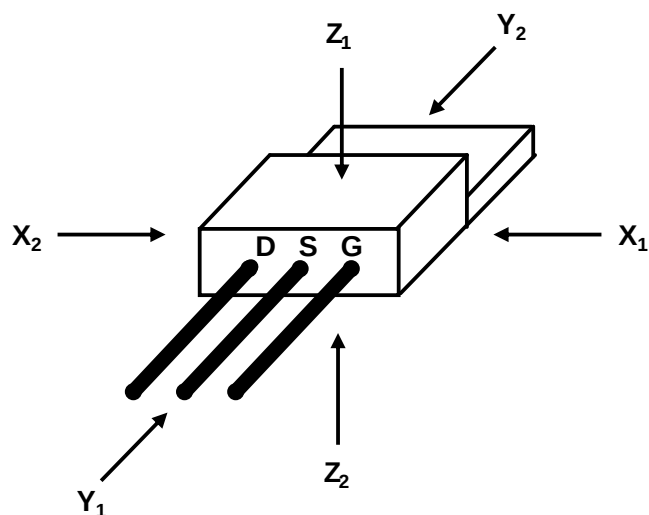


Figure 4. Orientation

JAXA R 2SK4048

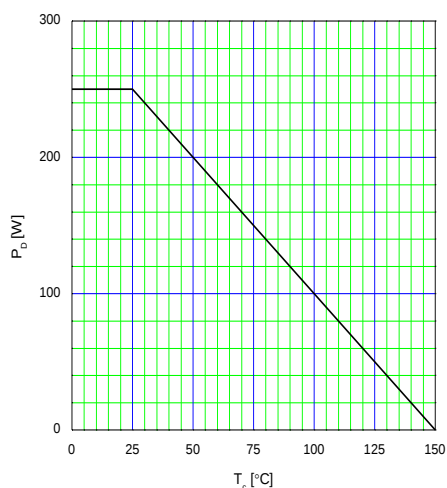


Fig. 5 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4048

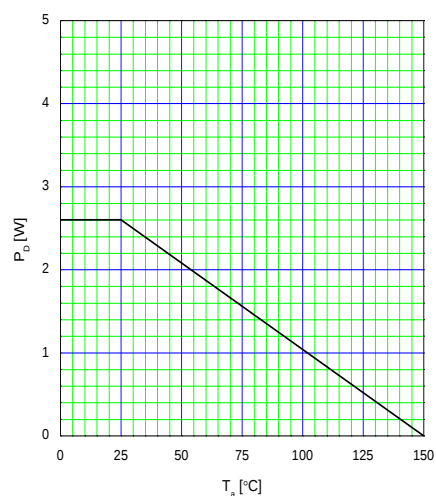


Fig. 6 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4048

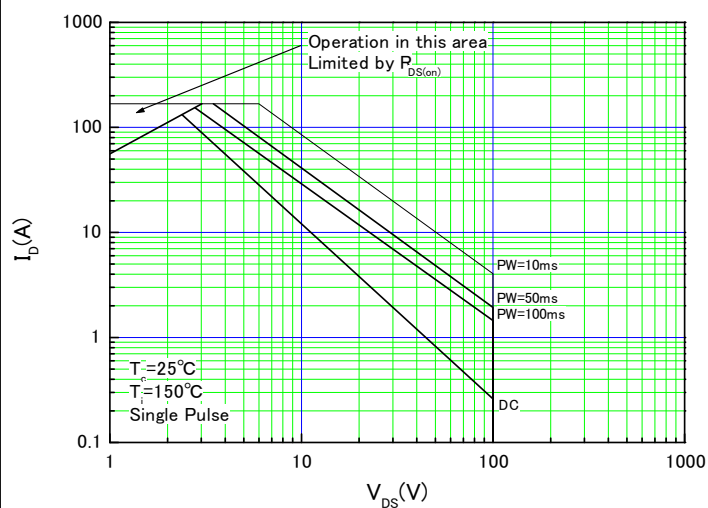


Fig. 7 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4049

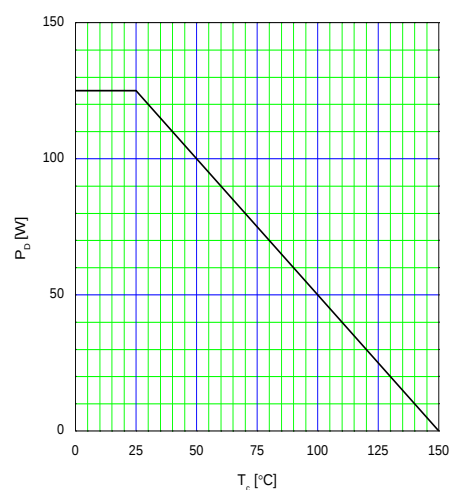


Fig. 8 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4049

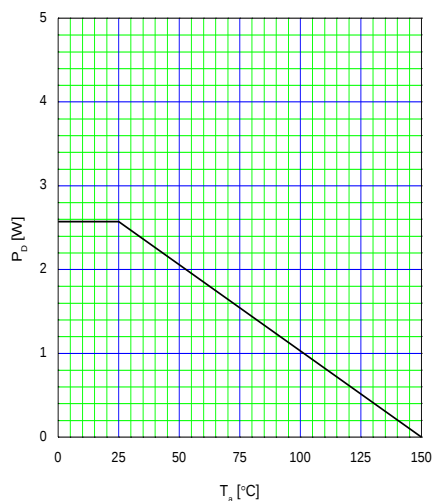


Fig. 9 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4049

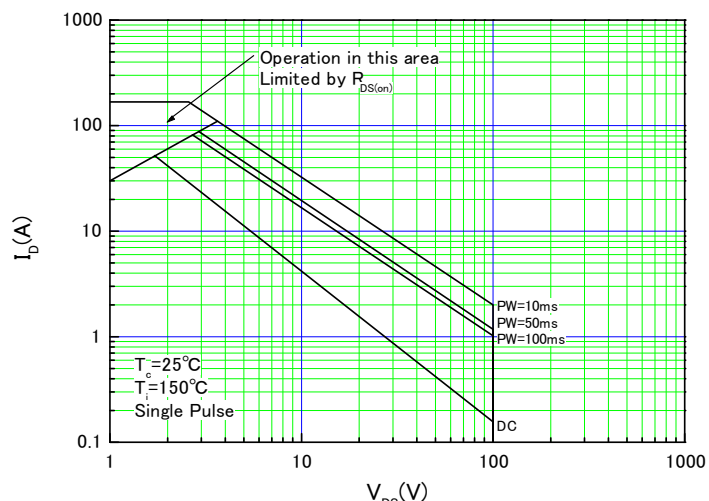


Fig. 10 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4050

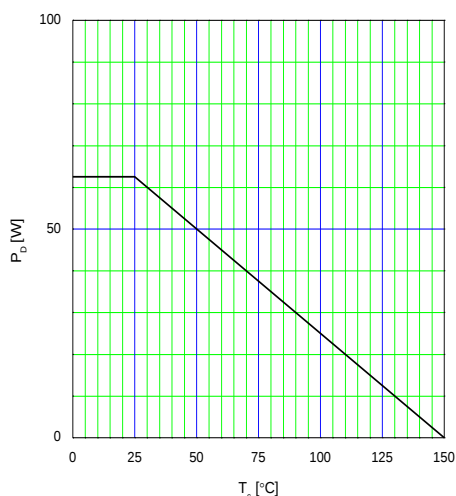


Fig. 11 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4050

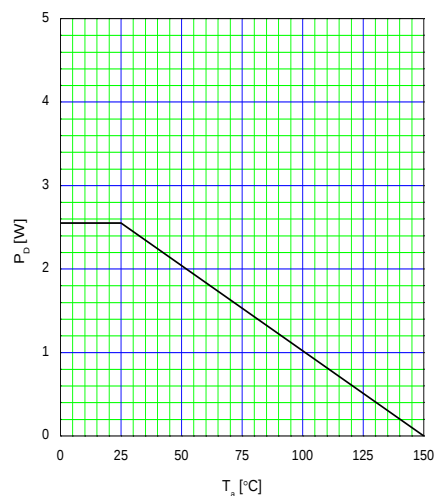


Fig. 12 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4050

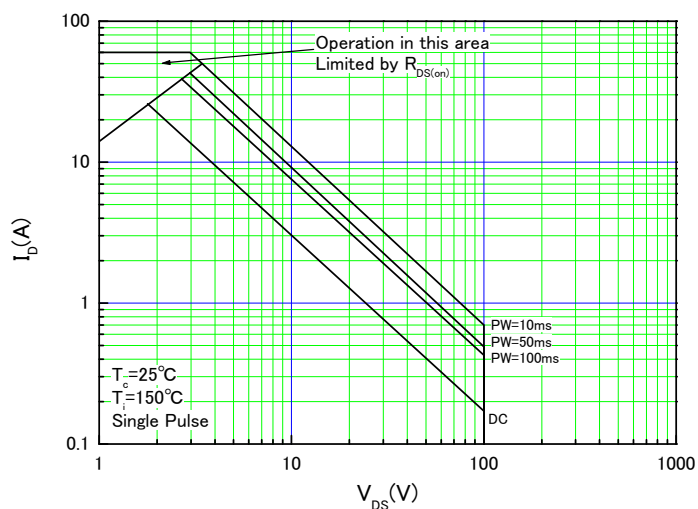


Fig. 13 Maximum Safe Operating Area $I_D = f(V_{DS})$

JAXA R 2SK4051

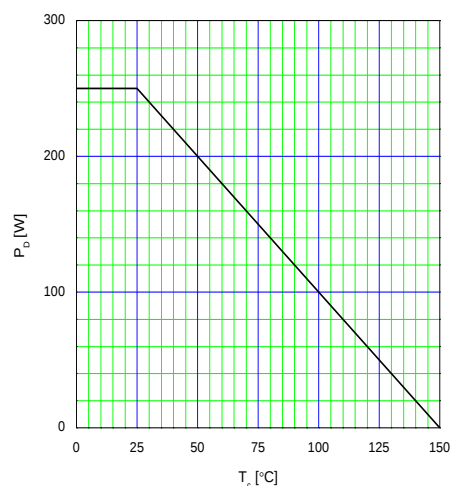


Fig. 14 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4051

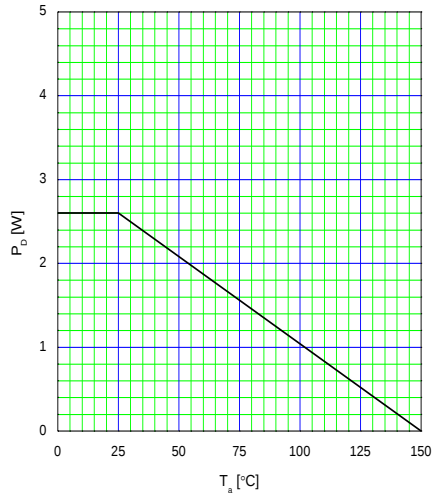


Fig. 15 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4051

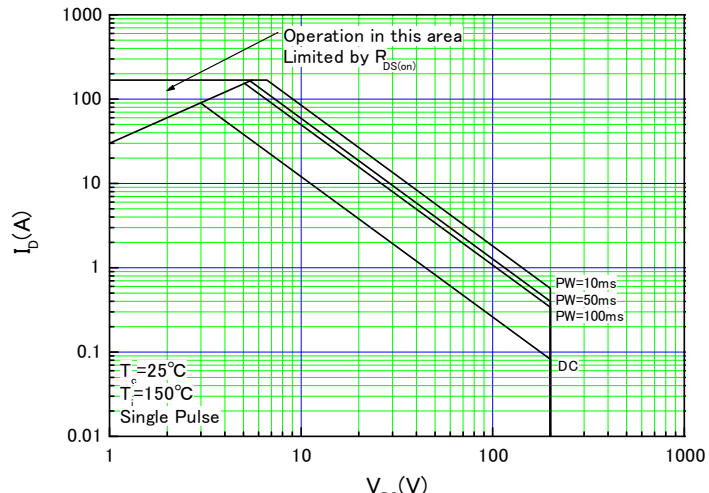


Fig. 16 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4052

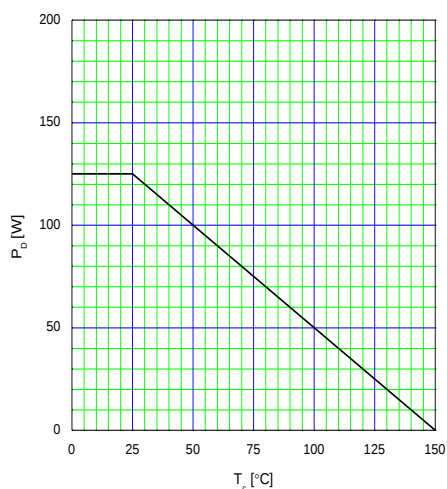


Fig. 17 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4052

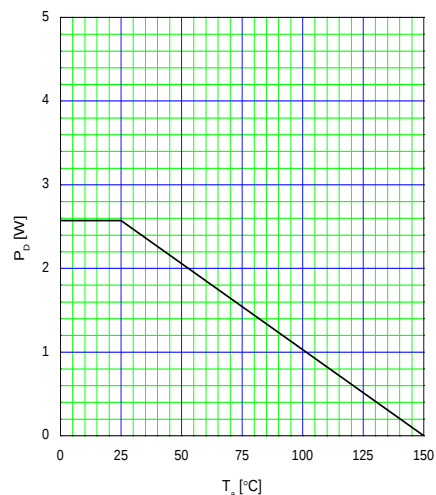


Fig. 18 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4052

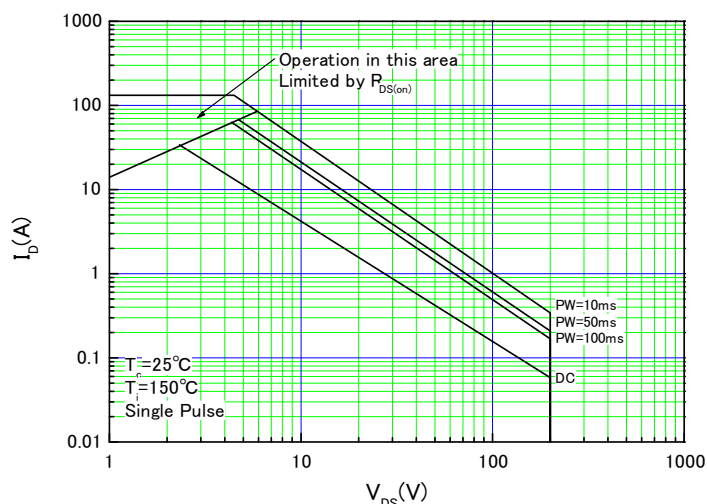


Fig. 19 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4053

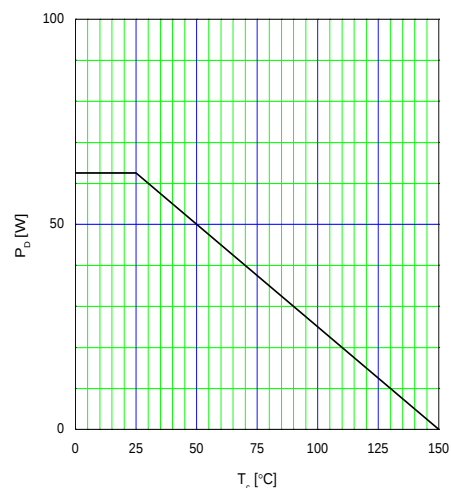


Fig. 20 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4053

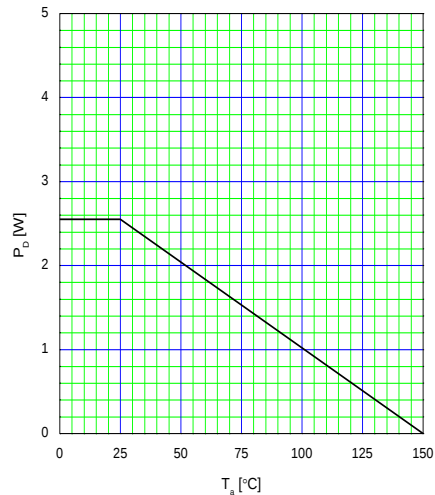


Fig. 21 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4053

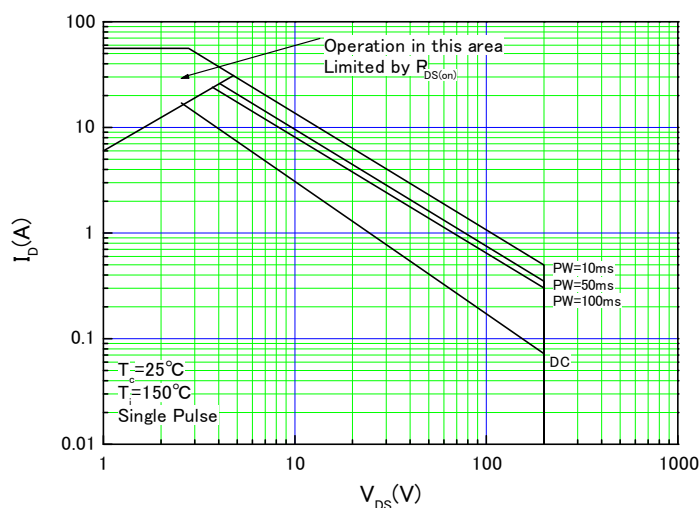


Fig. 22 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4054

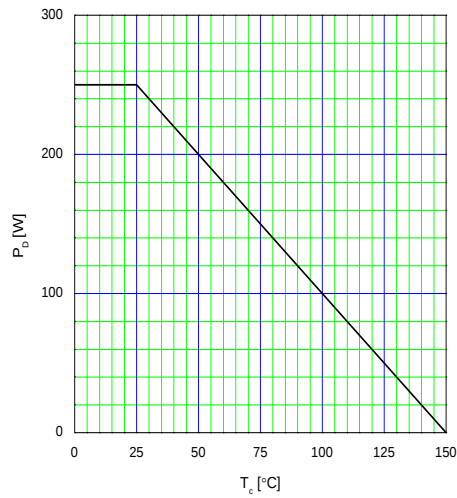


Fig. 23 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4054

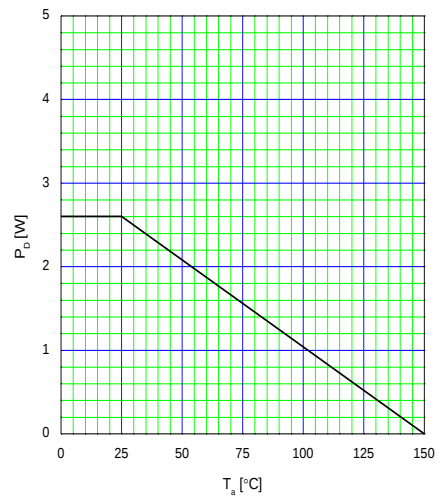


Fig. 24 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4054

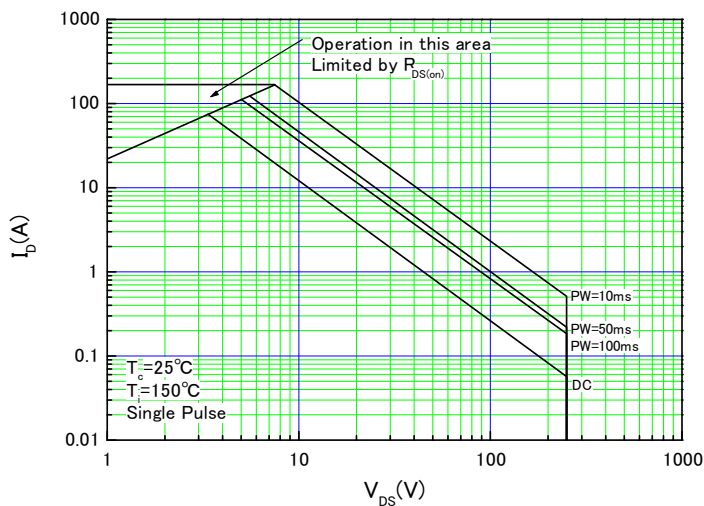


Fig. 25 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4055

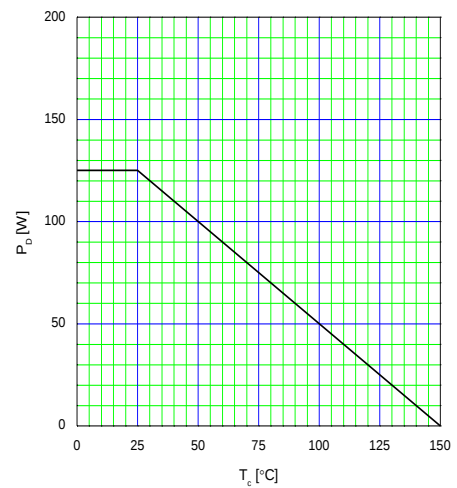


Fig. 26 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4055

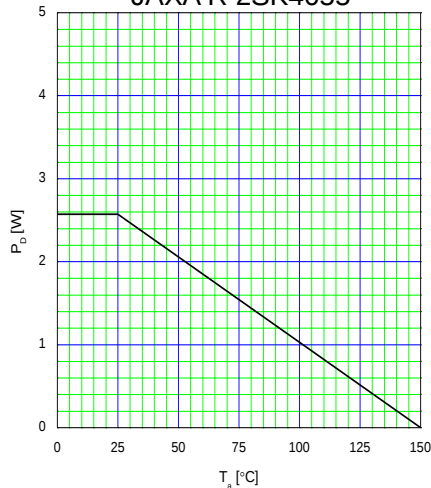


Fig. 27 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4055

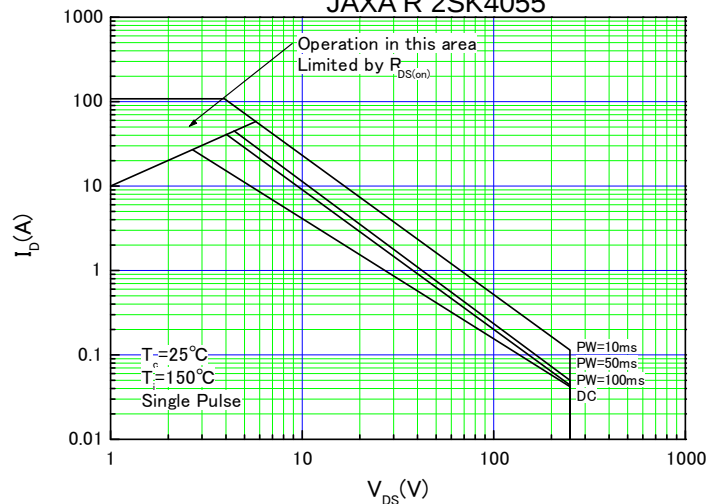


Fig. 28 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4056

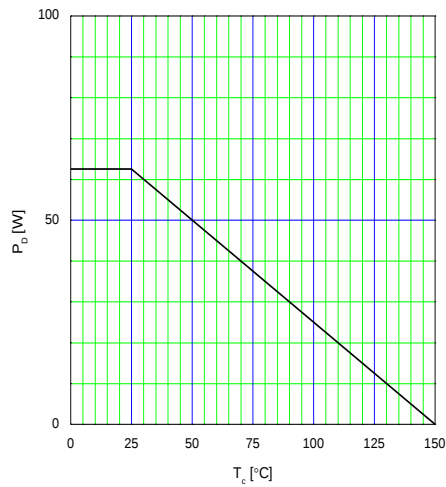


Fig. 29 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4056

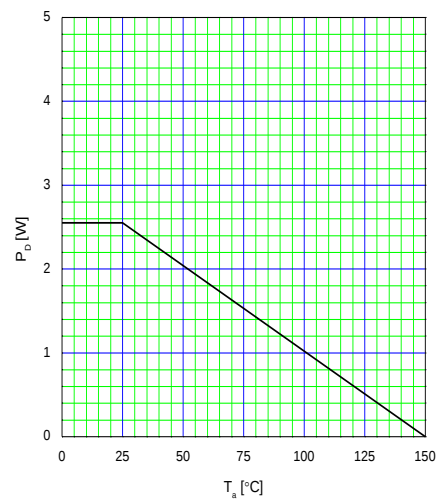


Fig. 30 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4056

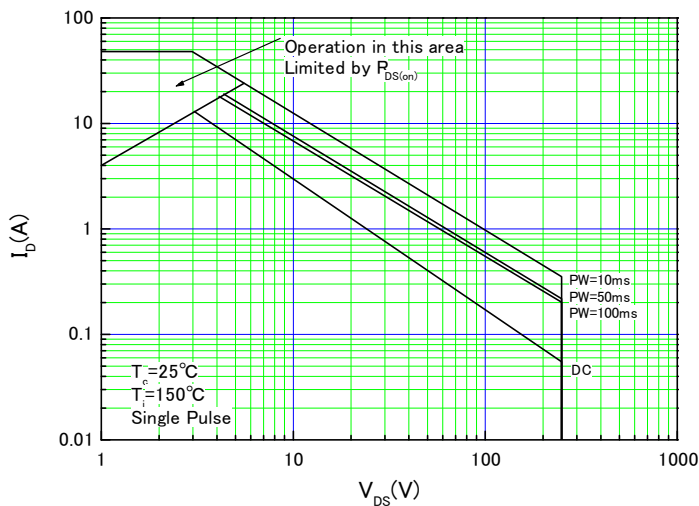


Fig. 31 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

JAXA R 2SK4214

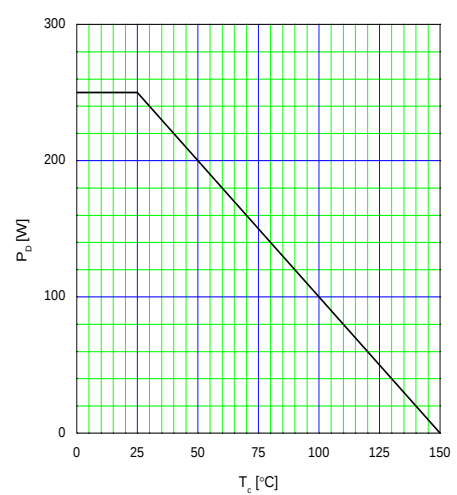


Fig. 32 Allowable Power Dissipation
 $P_D = f(T_c)$

JAXA R 2SK4214

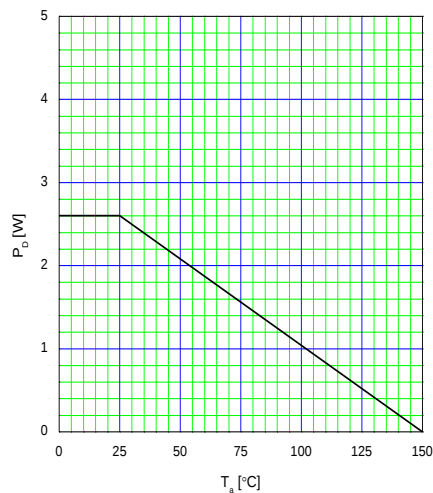


Fig. 33 Allowable Power Dissipation
 $P_D = f(T_a)$

JAXA R 2SK4214

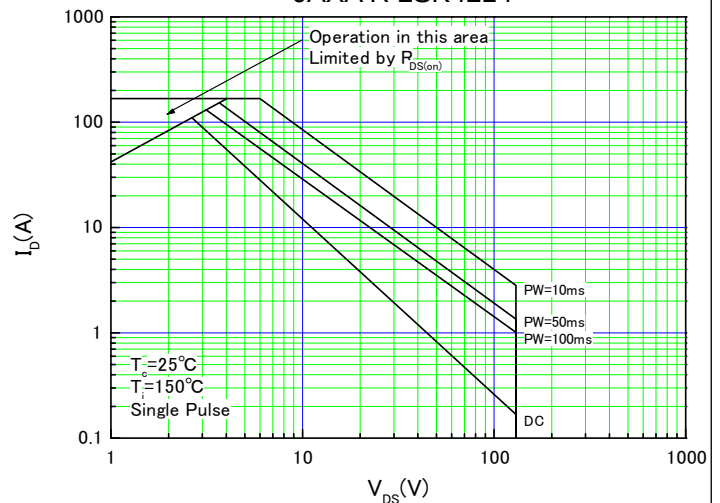


Fig. 34 Maximum Safe Operating Area
 $I_D = f(V_{DS})$

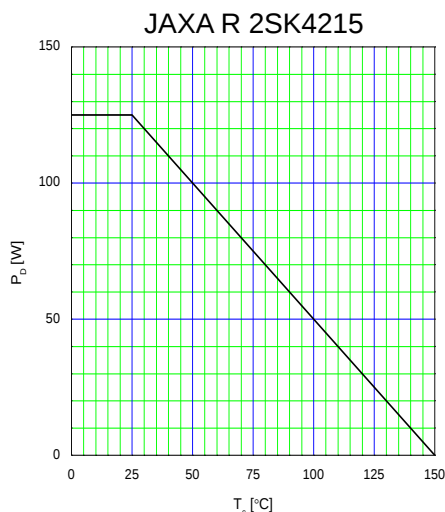


Fig. 35 Allowable Power Dissipation
 $P_D = f(T_c)$

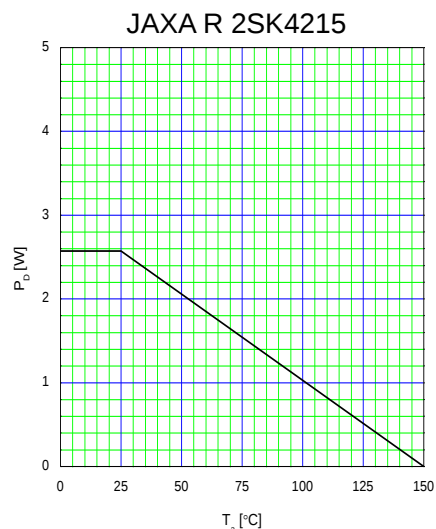


Fig. 36 Allowable Power Dissipation
 $P_D = f(T_a)$

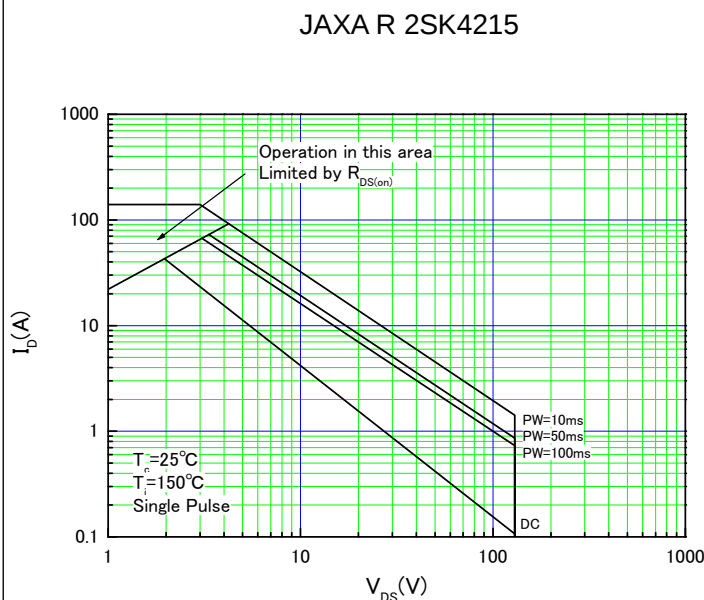


Fig. 37 Maximum Safe Operating Area $I_D - f(V_{DS})$

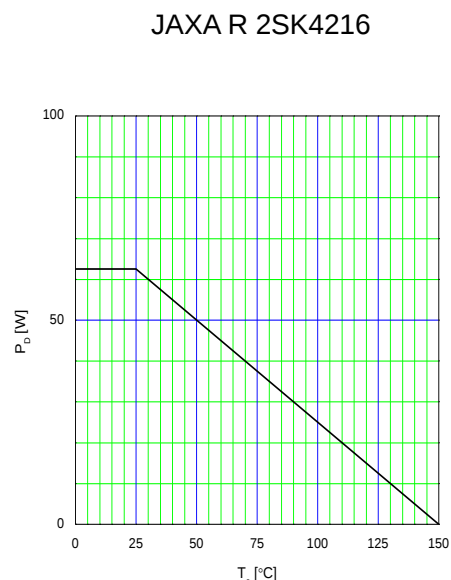


Fig. 38 Allowable Power Dissipation
 $P_D = f(T_c)$

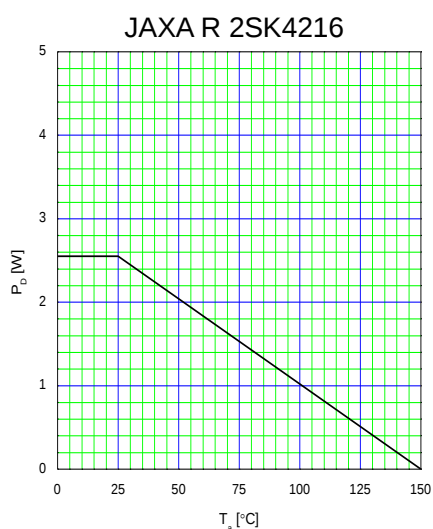


Fig. 39 Allowable Power Dissipation
 $P_D = f(T_r)$

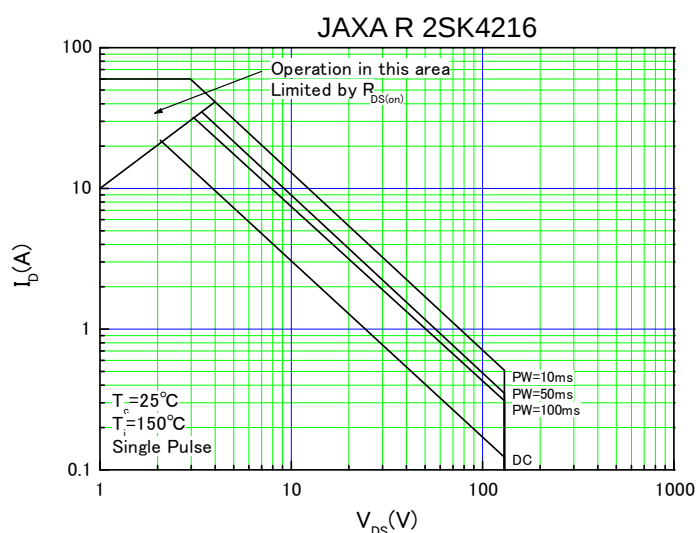


Fig. 40 Maximum Safe Operating Area
 $I_D = f(V_{DS})$